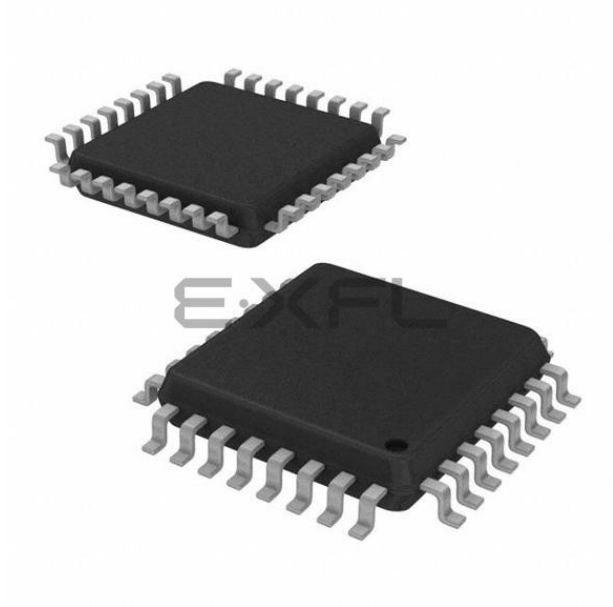

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	22
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f231-gqr

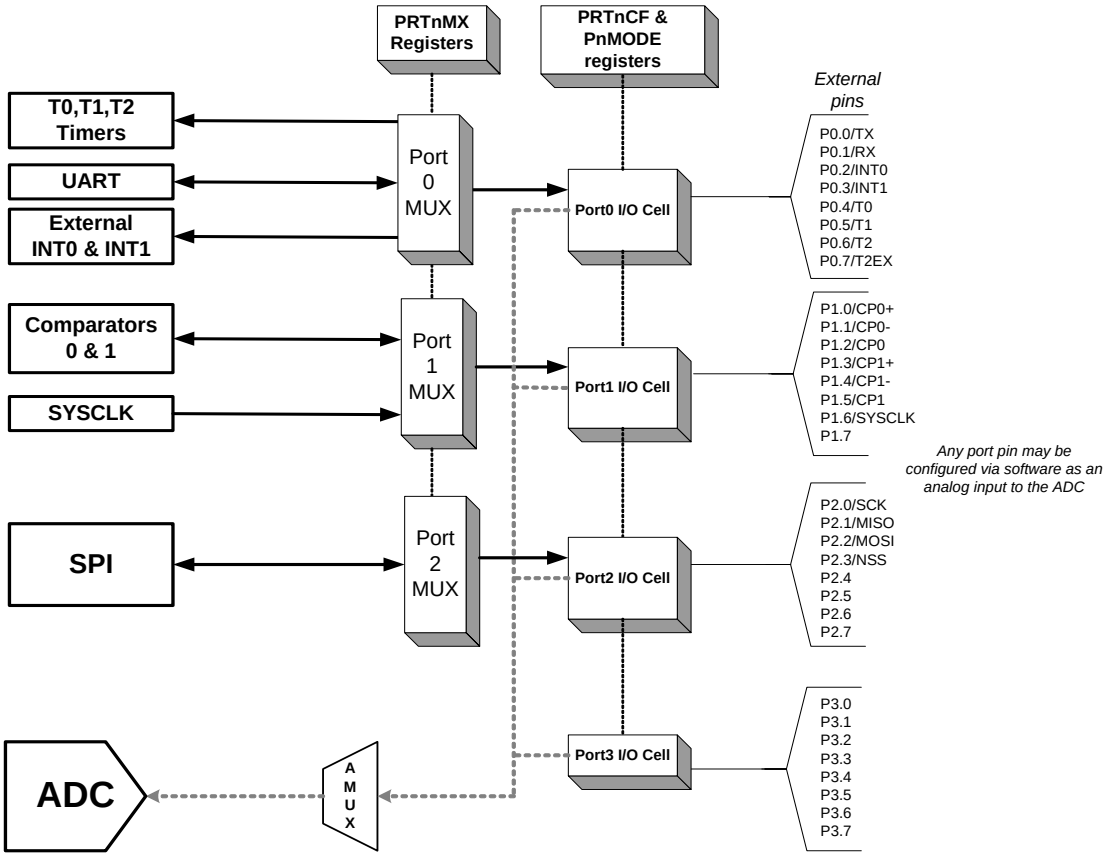

Figure 1.9. Port I/O Functional Block Diagram

1.5. Serial Ports

The C8051F206, C8051F220/1/6 and C8051F230/1/6 include a Full-Duplex UART and SPI Bus. Each of the serial buses is fully implemented in hardware and makes extensive use of the CIP-51's interrupts, thus requiring very little intervention by the CPU. The serial buses do not have to "share" resources such as timers, interrupts, or Port I/O, so both of the serial buses may be used simultaneously. (You may use Timer1, Timer 2, or SYSCLK to generate baud rates for UART).

1.6. Analog to Digital Converter

The C8051F220/1/6 has an on-chip 8-bit SAR ADC and the C8051F206 has a 12-bit SAR ADC with a programmable gain amplifier. With a maximum throughput of 100ksps, the ADC offers true 8-bit with an INL of ±1/4 LSB, and or 12-bit accuracy with ±2 LSB. The voltage reference can be the power supply (V_{DD}), or an external reference voltage (VREF). Also, the system controller can place the ADC into a power-saving shutdown mode when not in use. A programmable gain amplifier follows the analog multiplexer. The gain can be set in software from 0.5 to 16 in powers of 2.

Conversions can be initiated in two ways; a software command or an overflow on Timer 2. This flexibility allows the start of conversion to be triggered by software events, or convert continuously. A completed conversion causes an interrupt, or a status bit can be polled in software to determine the end of conversion. The resulting 8-bit data word is latched into an SFR upon completion of a conversion.

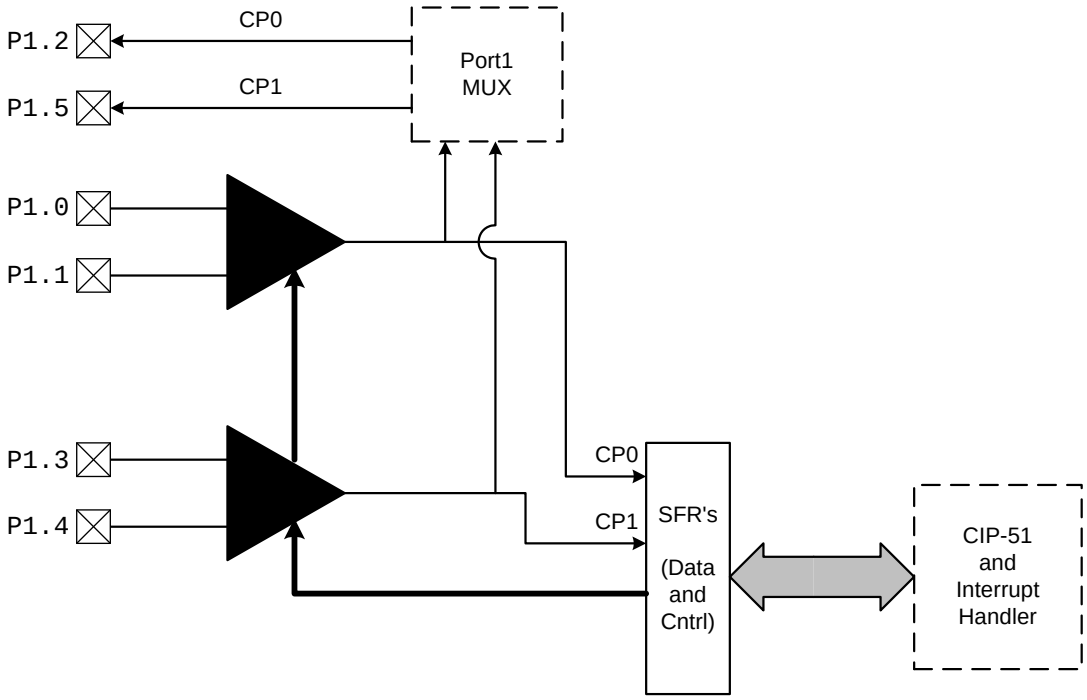

Figure 1.11. Comparator Diagram

5.2. ADC Modes of Operation

The ADC has a maximum conversion speed of 100ksps. The ADC conversion clock is derived from the system clock. The ADC conversion clock is derived from a divided version of SYSCLK. Divide ratios of 1,2,4,8, or 16 are supported by setting the ADCSC bits in the ADC0CF Register. This is useful to adjust conversion speed to accommodate different system clock speeds.

A conversion can be initiated in one of two ways, depending on the programmed states of the ADC Start of Conversion Mode bits (ADSTM1, ADSTM0) in ADC0CN. Conversions may be initiated by:

1. Writing a 1 to the ADBUSY bit of ADC0CN;
2. A Timer 2 overflow (i.e., timed continuous conversions).

Writing a 1 to ADBUSY provides software control of the ADC whereby conversions are performed "on-demand". During conversion, the ADBUSY bit is set to 1 and restored to 0 when conversion is complete. The falling edge of ADBUSY triggers an interrupt (when enabled) and sets the ADCINT interrupt flag in the ADC0CN register. Note: When conversions are performed "on-demand", the ADCINT flag, not ADBUSY, should be polled to determine when the conversion has completed. Converted data is available in the ADC data word register, ADC0H.

The ADCTM bit in register ADC0CN controls the ADC track-and-hold mode. In its default state, the ADC input is continuously tracked, except when a conversion is in progress. Setting ADCTM to 1 allows one of two different low power track-and-hold modes to be specified by states of the ADSTM1-0 bits (also in ADC0CN):

1. Tracking begins with a write of 1 to ADBUSY and lasts for 3 SAR clocks;
2. Tracking starts with an overflow of Timer 2 and lasts for 3 SAR clocks.

Tracking can be disabled (shutdown) when the entire chip is in low power standby or sleep modes.

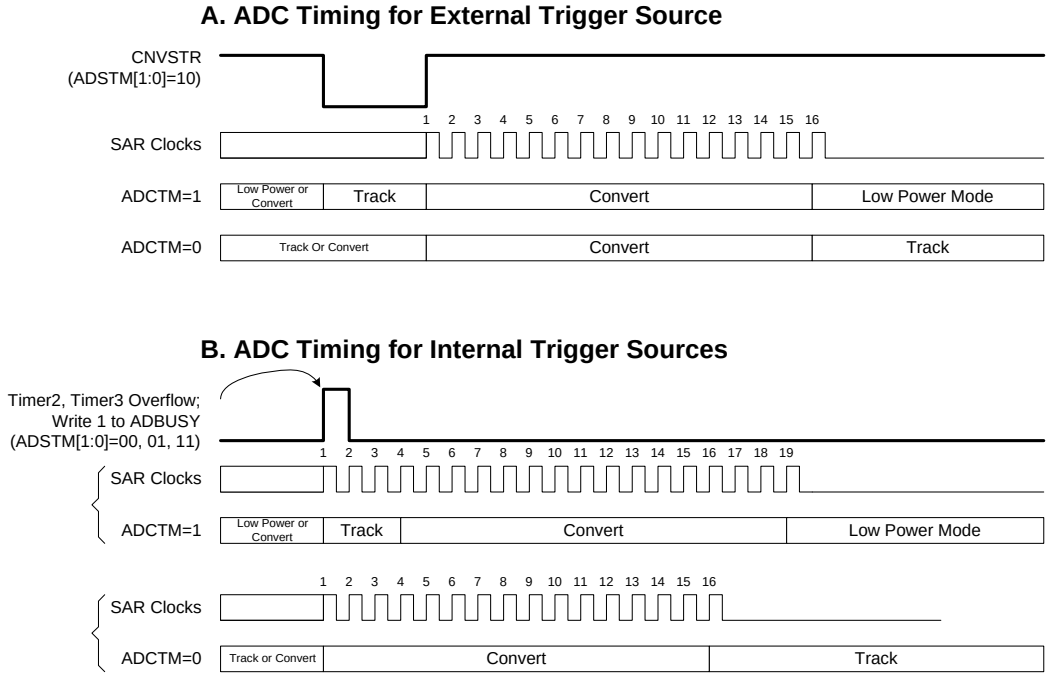

Figure 5.2. 12-Bit ADC Track and Conversion Example Timing

SFR Definition 5.3. ADC0CN: ADC Control (C8051F220/1/6 and C8051F206)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ADCEN	ADCTM	ADCINT	ADBUSY	ADSTM1	ADSTM0	ADWINT	ADLJST	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xE8

Bit7: ADCEN: ADC Enable Bit
0: ADC Disabled. ADC is in low power shutdown.
1: ADC Enabled. ADC is active and ready for data conversions.

Bit6: ADCTM: ADC Track Mode Bit
0: When the ADC is enabled, tracking is continuous unless a conversion is in process
1: Tracking Defined by ADSTM1-0 bits
ADSTM1-0:
00: Tracking starts with the write of 1 to ADBUSY and lasts for 3 SAR clocks
01: RESERVED
10: RESERVED
11: Tracking started by the overflow of Timer 2 and last for 3 SAR clocks

Bit5: ADCINT: ADC Conversion Complete Interrupt Flag (cleared by software).
0: ADC has not completed a data conversion since the last time this flag was cleared
1: ADC has completed a data conversion

Bit4: ADBUSY: ADC Busy Bit
Read
0: ADC Conversion complete or no valid data has been converted since a reset. The falling edge of ADBUSY generates an interrupt when enabled.
1: ADC Busy converting data
Write
0: No effect
1: Starts ADC Conversion if ADSTM1-0 = 00b

Bits3–2: ADSTM1–0: ADC Start of Conversion Mode Bits
00: ADC conversion started upon a write of 1 to ADBUSY
01: RESERVED
10: RESERVED
11: ADC conversions initiated on overflows of Timer 2

Bit1: ADWINT: ADC Window Compare Interrupt Flag
0: ADC Window Comparison Data match has not occurred
1: ADC Window Comparison Data match occurred

Bit0: ADLJST: ADC Left Justify Data Bit (Used on C8051F206 only)
0: Data in ADC0H:ADC0L registers are right justified.
1: Data in ADC0H:ADC0L registers are left justified.

Table 5.1. 8-Bit ADC Electrical Characteristics

VDD = 3.0 V, VREF = 2.40 V, PGA Gain = 1, –40 to +85 ×C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution		—	8	—	bits
Integral Nonlinearity		—	—	±1/2	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	—	±1/2	LSB
Offset Error		±2	—	±1/2	LSB
Gain Error		±2	—	±1/2	LSB
Offset Temperature Coefficient			±0.25	—	ppm/°C
Dynamic Performance (10 kHz sine-wave input, 0 to –1 dB of full scale, 100 ksps)					
Signal-to-Noise Plus Distortion		49.5	—	—	dB
Total Harmonic Distortion	Up to the 5th harmonic	–60	–65	—	dB
Spurious-Free Dynamic Range		—	–65	—	dB
Conversion Rate					
Conversion Time in SAR Clocks		16	—	—	clocks
SAR Clock Frequency			—	2.5	MHz
Track/Hold Acquisition Time		1.5	—	—	µs
Throughput Rate		—	—	100	ksps
Analog Inputs					
Input Voltage Range		0	—	V_{DD}	V
Input Capacitance		—	10	—	pF
Power Specifications					
Power Supply Current	Operating Mode, 100 ksps	—	0.45	1.0	mA
Power Supply Current in Shutdown		—	0.1	1	µA
Power Supply Rejection		—	±0.3	—	mV/V

6. ADC (12-Bit, C8051F206 Only)

Description

The ADC subsystem for the C8051F206 consists of configurable analog multiplexer (AMUX), a programmable gain amplifier (PGA), and a 100ksps, 12-bit successive-approximation-register ADC with integrated track-and-hold and programmable window detector (see Figure 6.1). The AMUX, PGA, Data Conversion Modes, and Window Detector are all configurable under software control via the Special Function Register's shown in Figure 6.1. The ADC subsystem (ADC, track-and-hold and PGA) is enabled only when the ADCEN bit in the ADC Control register (ADC0CN, Figure 6.5) is set to 1. The ADC subsystem is in low power shutdown when this bit is 0.

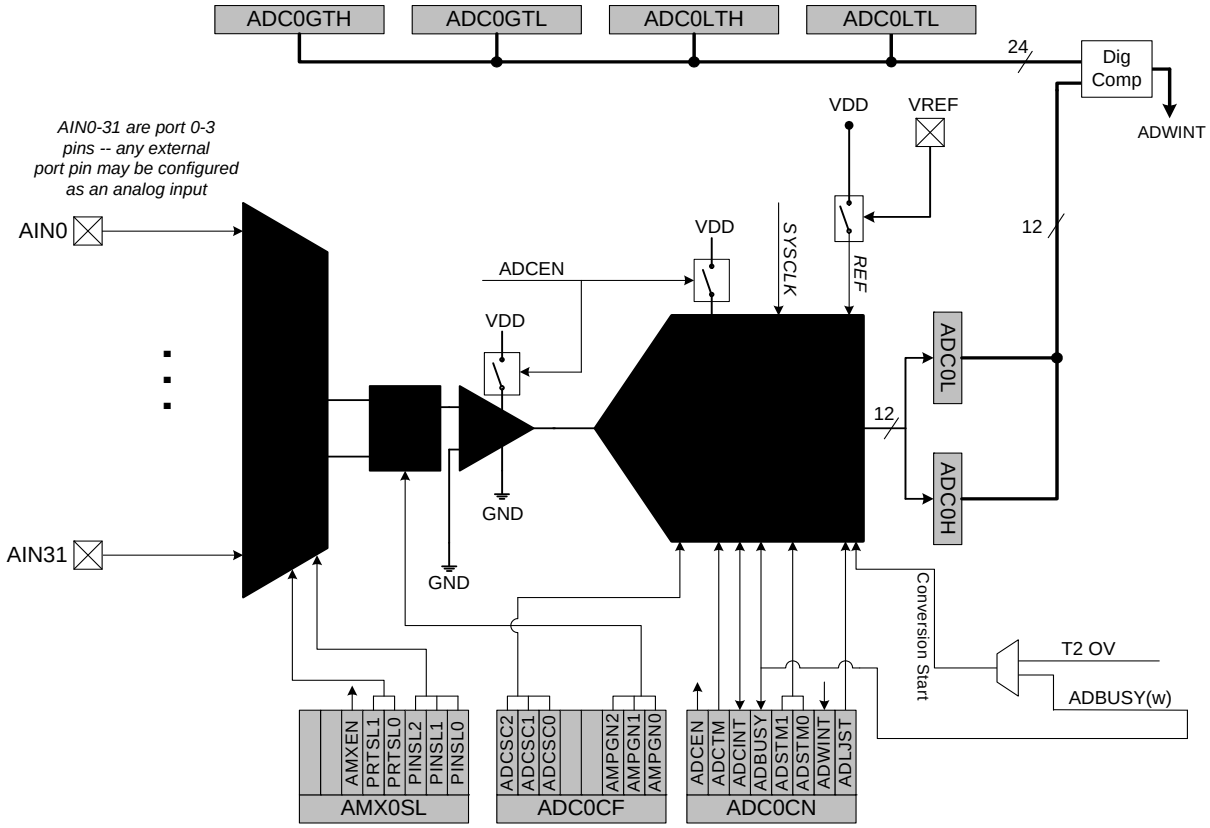

Figure 6.1. 12-Bit ADC Functional Block Diagram

6.1. Analog Multiplexer and PGA

Any external port pin (ports 0-3) may be selected via software. The AMX0SL SFR is used to select the desired analog input pin. (See SFR Definition 5.1). When the AMUX is enabled, the user selects which port is to be used (bits PRTSL0–1), and then the pin in the selected port (bits PINSL0–2) to be the analog input.

The PGA amplifies the AMUX output signal by an amount determined by the states of the AMPGN2–0 bits in the ADC Configuration register, ADC0CF (SFR Definition 5.2). The PGA can be software-programmed for gains of 0.5, 1, 2, 4, 8 or 16. It defaults to a gain of 1 on reset.

Table 9.1. CIP-51 Instruction Set Summary (Continued)

Mnemonic	Description	Bytes	Clock Cycles
INC @Ri	Increment indirect RAM	1	2
DEC A	Decrement A	1	1
DEC Rn	Decrement register	1	1
DEC direct	Decrement direct byte	2	2
DEC @Ri	Decrement indirect RAM	1	2
INC DPTR	Increment Data Pointer	1	1
MUL AB	Multiply A and B	1	4
DIV AB	Divide A by B	1	8
DA A	Decimal Adjust A	1	1
Logical Operations			
ANL A,Rn	AND Register to A	1	1
ANL A,direct	AND direct byte to A	2	2
ANL A,@Ri	AND indirect RAM to A	1	2
ANL A,#data	AND immediate to A	2	2
ANL direct,A	AND A to direct byte	2	2
ANL direct,#data	AND immediate to direct byte	3	3
ORL A,Rn	OR Register to A	1	1
ORL A,direct	OR direct byte to A	2	2
ORL A,@Ri	OR indirect RAM to A	1	2
ORL A,#data	OR immediate to A	2	2
ORL direct,A	OR A to direct byte	2	2
ORL direct,#data	OR immediate to direct byte	3	3
XRL A,Rn	Exclusive-OR Register to A	1	1
XRL A,direct	Exclusive-OR direct byte to A	2	2
XRL A,@Ri	Exclusive-OR indirect RAM to A	1	2
XRL A,#data	Exclusive-OR immediate to A	2	2
XRL direct,A	Exclusive-OR A to direct byte	2	2
XRL direct,#data	Exclusive-OR immediate to direct byte	3	3
CLR A	Clear A	1	1
CPL A	Complement A	1	1
RL A	Rotate A left	1	1
RLC A	Rotate A left through carry	1	1
RR A	Rotate A right	1	1
RRC A	Rotate A right through carry	1	1
SWAP A	Swap nibbles of A	1	1
Data Transfer			
MOV A,Rn	Move register to A	1	1
MOV A,direct	Move direct byte to A	2	2
MOV A,@Ri	Move indirect RAM to A	1	2

9.2. Memory Organization

The memory organization of the CIP-51 System Controller is similar to that of a standard 8051. There are two separate memory spaces: program memory and data memory. Program and data memory share the same address space but are accessed via different instruction types. There are 256 bytes of internal data memory and 8 kB of internal program memory address space implemented within the CIP-51. The CIP-51 memory organization is shown in Figure 9.2.

9.2.1. Program Memory

The CIP-51 has a 8 kB program memory space. The MCU implements 8320 bytes of this program memory space as in-system, reprogrammable Flash memory, organized in a contiguous block from addresses 0x0000 to 0x207F. Note: 512 bytes (0x1E00 – 0x1FFF) of this memory are reserved for factory use and are not available for user program storage.

Program memory is normally assumed to be read-only. However, the CIP-51 can write to program memory by setting the Program Store Write Enable bit (PSCTL.0) and using the MOVX instruction. This feature provides a mechanism for the CIP-51 to update program code and use the program memory space for non-volatile data storage. Refer to Section 10 Flash Memory for further details.

9.2.2. Data Memory

The CIP-51 implements 256 bytes of internal RAM mapped into the data memory space from 0x00 through 0xFF. The lower 128 bytes of data memory are used for general purpose registers and memory. Either direct or indirect addressing may be used to access the lower 128 bytes of data memory. Locations 0x00 through 0x1F are addressable as four banks of general purpose registers, each bank consisting of eight byte-wide registers. The next 16 bytes, locations 0x20 through 0x2F, may either be addressed as bytes or as 128 bit locations accessible with the direct bit addressing mode.

The upper 128 bytes of data memory are accessible only by indirect addressing. This region occupies the same address space as the Special Function Registers (SFR) but is physically separate from the SFR space. The addressing mode used by an instruction when accessing locations above 0x7F determines whether the CPU accesses the upper 128 bytes of data memory space or the SFRs. Instructions that use direct addressing will access the SFR space. Instructions using indirect addressing above 0x7F will access the upper 128 bytes of data memory. Figure 9.2 illustrates the data memory organization of the CIP-51.

Additionally, the C8051F206/226/236 feature 1024 Bytes of RAM mapped in the external data memory space. All address locations may be accessed using the MOVX instruction. (Please see Section 11).

SFR Definition 9.4. PSW: Program Status Word

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R	Reset Value
CY	AC	F0	RS1	RS0	OV	F1	PARITY	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xD0

Bit7: CY: Carry Flag.
This bit is set when the last arithmetic operation results in a carry (addition) or a borrow (subtraction). It is cleared to 0 by all other arithmetic operations.

Bit6: AC: Auxiliary Carry Flag.
This bit is set when the last arithmetic operation results in a carry into (addition) or a borrow from (subtraction) the high order nibble. It is cleared to 0 by all other arithmetic operations.

Bit5: F0: User Flag 0.
This is a bit-addressable, general-purpose flag for use under software control.

Bits4–3: RS1–RS0: Register Bank Select.
These bits select which register bank is used during register accesses.

RS1	RS0	Register Bank	Address
0	0	0	0x00–0x07
0	1	1	0x08–0x0F
1	0	2	0x10–0x17
1	1	3	0x18–0x1F

Note: Any instruction which changes the RS1–RS0 bits must not be immediately followed by the “MOV Rn, A” instruction.

Bit2: OV: Overflow Flag.
This bit is set to 1 under the following circumstances:
•An ADD, ADDC, or SUBB instruction causes a sign-change overflow.
•A MUL instruction results in an overflow (result is greater than 255).
•A DIV instruction causes a divide-by-zero condition.
The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases.

Bit1: F1: User Flag 1.
This is a bit-addressable, general purpose flag for use under software control.

Bit0: PARITY: Parity Flag.
This bit is set to 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even.

SFR Definition 9.11. EIE2: Extended Interrupt Enable 2

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
EXVLD	-	ESCI3	ESCI2	ESCI1	ESCI0	EADC0	-	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xE7

Bit7: EXVLD: Enable External Clock Source Valid (XTLVLD) Interrupt.
This bit sets the masking of the XTLVLD interrupt.
0: Disable all XTLVLD interrupts.
1: Enable interrupt requests generated by the XTLVLD flag (OSCXCN.7)

Bit6: Reserved. Must write 0. Reads 0.

Bit5: ESCI3: Enable Software Controlled Interrupt 3.
This bit sets the masking of Software Controlled Interrupt 3.
0: Disable Software Controlled Interrupt 3.
1: Enable interrupt requests generated setting the Software Controlled Interrupt Bit 3.

Bit4: ESCI2: Enable Software Controlled Interrupt 2.
This bit sets the masking of Software Controlled Interrupt 2.
0: Disable Software Controlled Interrupt 2.
1: Enable interrupt requests generated setting the Software Controlled Interrupt Bit 2.

Bit3: ESCI1: Enable Software Controlled Interrupt 1.
This bit sets the masking of Software Controlled Interrupt 1.
0: Disable Software Controlled Interrupt 1.
1: Enable interrupt requests generated setting the Software Controlled Interrupt Bit 1.

Bit2: ESCI0: Enable Software Controlled Interrupt 0.
This bit sets the masking of Software Controlled Interrupt 0.
0: Disable Software Controlled Interrupt 0.
1: Enable interrupt requests generated setting the Software Controlled Interrupt Bit 0.

Bit1: EADC0: Enable ADC0 End of Conversion Interrupt.
This bit sets the masking of the ADC0 End of Conversion Interrupt.
0: Disable ADC0 Conversion Interrupt.
1: Enable interrupt requests generated by the ADC0 Conversion Interrupt.

Bit0: Reserved. Read = 0, Write = don't care.

11. On-Chip XRAM (C8051F206/226/236)

The C8051F206/226/236 features 1024 Bytes of RAM mapped into the external data memory space. All address locations may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using indirect MOVX addressing mode. If the MOVX instruction is used with an 8-bit operand (such as @R1), then the high byte is the External Memory Interface Control Register (EMI0CN, shown in SFR Definition 11.1). Addressing using 8 bits will map to one of four 256-byte pages, and these pages are selected by setting the PGSEL bits in the EMI0CN register.

NOTE: The MOVX instruction is also used for write to the Flash memory. Please see section 10 for details. The MOVX instruction will access XRAM by default.

For any of the addressing modes, the upper 6 bits of the 16-bit external data memory address word are "don't cares". As a result, the 1024-byte RAM is mapped modulo style ("wrap around") over the entire 64k of possible address values. For example, the XRAM byte at address 0x0000 is also at address 0x0400, 0x0800, 0x0C00, 0x1000, etc. This feature is useful when doing a linear memory fill, as the address pointer does not have to be reset when reaching the RAM block boundary.

SFR Definition 11.1. EMI0CN: External Memory Interface Control

R	R	R	R	R	R	R/W	R/W	Reset Value
-	-	-	-	-	-	PGSEL1	PGSEL0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xAF

Bits7–2: Not Used -read only 000000b
Bits1–0: XRAM Page Select Bits PGSEL[1:0]
The XRAM Page Select bits provide the high byte of the 16-bit external memory address when using an 8-bit MOVX command, effectively selecting a 256-byte page of RAM. The upper 6 bits are "don't cares", so the 1k address blocks are repeated modulo over the entire data memory address space.
00:0x000 – 0x0FF
01:0x100 – 0x1FF
10:0x200 – 0x2FF
11:0x300 – 0x3FF

13. Oscillator

The MCU includes an internal oscillator and an external oscillator drive circuit, either of which can generate the system clock. The MCU boots from the internal oscillator after any reset. This internal oscillator can be enabled/disabled and its frequency can be set using the Internal Oscillator Control Register (OSCICN) as shown in SFR Definition 13.1. The internal oscillator's electrical specifications are given in Table 13.1.

Both oscillators are disabled when the $\overline{\text{RST}}$ pin is held low. The MCU can run from the internal oscillator permanently, or it can switch to the external oscillator if desired using CLKSL bit in the OSCICN Register. The external oscillator requires an external resonator, crystal, capacitor, or RC network connected to the XTAL1/XTAL2 pins (see Figure 13.1). The oscillator circuit must be configured for one of these sources in the OSCXCN register. An external CMOS clock can also provide the system clock by driving the XTAL1 pin. The XTAL1 and XTAL2 pins are NOT 5 V tolerant.

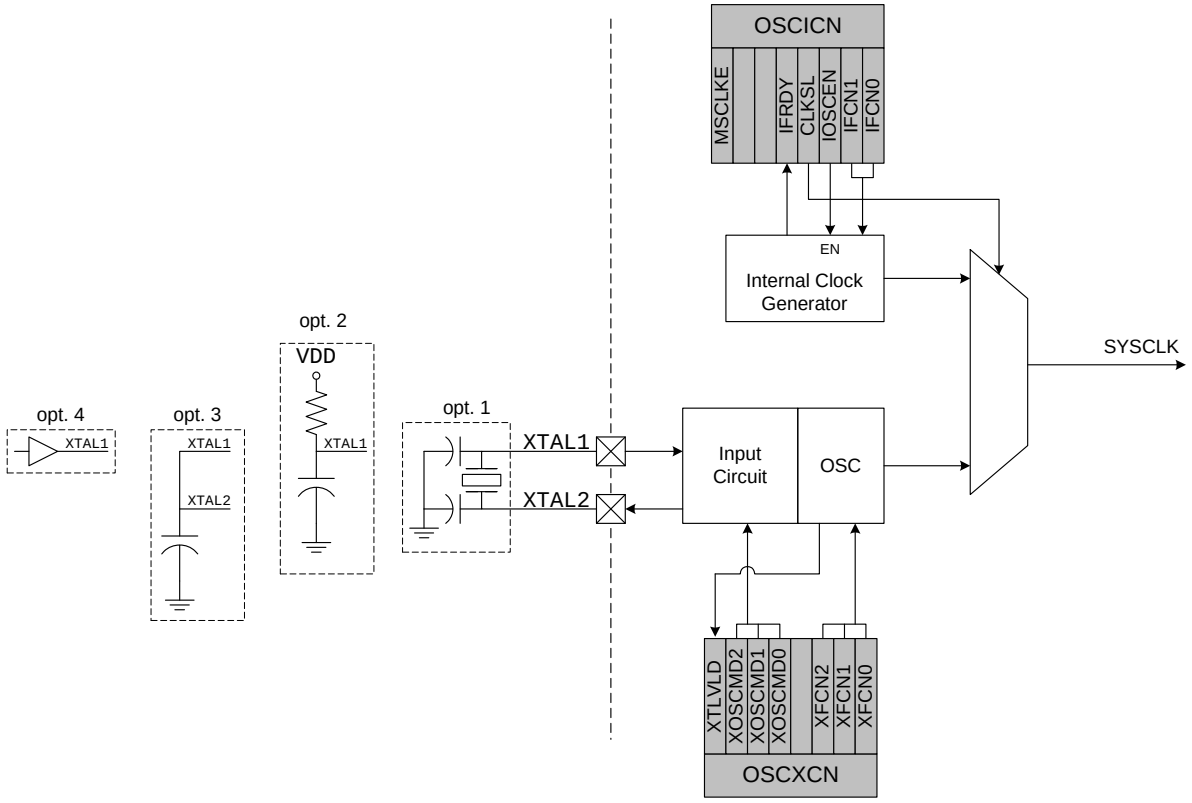

Figure 13.1. Oscillator Diagram

SFR Definition 13.1. OSCICN: Internal Oscillator Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
MSCLKE	-	-	IFRDY	CLKSL	IOSCEN	IFCN1	IFCN0	00000100
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB2

Bit7: MSCLKE: Missing Clock Enable Bit
0: Missing Clock Detector Disabled
1: Missing Clock Detector Enabled; triggers a reset if a missing clock is detected
Bits6–5: UNUSED. Read = 00b, Write = don't care
Bit4: IFRDY: Internal Oscillator Frequency Ready Flag
0: Internal Oscillator Frequency not running at speed specified by the IFCN bits.
1: Internal Oscillator Frequency running at speed specified by the IFCN bits.
Bit3: CLKSL: System Clock Source Select Bit
0: Uses Internal Oscillator as System Clock.
1: Uses External Oscillator as System Clock.
Bit2: IOSCEN: Internal Oscillator Enable Bit
0: Internal Oscillator Disabled
1: Internal Oscillator Enabled
Bits1–0: IFCN1-0: Internal Oscillator Frequency Control Bits
00: Internal Oscillator typical frequency is 2 MHz.
01: Internal Oscillator typical frequency is 4 MHz.
10: Internal Oscillator typical frequency is 8 MHz.
11: Internal Oscillator typical frequency is 16 MHz.

Table 13.1. Internal Oscillator Electrical Characteristics

–40 to +85 ×C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Internal Oscillator Frequency	OSCICN.[1:0] = 00 OSCICN.[1:0] = 01 OSCICN.[1:0] = 10 OSCICN.[1:0] = 11	1.5 3.0 6.0 12	2.0 4.0 8.0 16	2.5 5.0 10 20	MHz
Internal Oscillator Current Consumption	OSCICN.2 = 1	—	200	—	µA
Internal Oscillator Temperature Stability		—	4	—	ppm/°C
Internal Oscillator Power Supply (V_{DD}) Stability		—	6.4	—	%/V

SFR Definition 14.9. P1MODE: Port1 Digital/Analog Input Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF2

Bits7–0: Port1 Digital/Analog Output Mode
0: Corresponding Port1 pin Digital Input disabled. (For analog use, i.e., ADC or comparators).
1: Corresponding Port1 pin Digital Input is enabled.

SFR Definition 14.10. P2: Port2 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0	11111111
Bit7	Bit6	Bit	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xA0

Bits7–0: P2.[7:0]
(Write - Output appears on I/O pins per PRT0MX, PRT1MX, and PRT2MX registers)
0: Logic Low Output.
1: Logic High Output (high impedance if corresponding PRT2CF.n bit = 0)
(Read - Regardless of PRT0MX, PRT1MX, and PRT2MX Register settings).
0: P2.n is logic low.
1: P2.n is logic high.

SFR Definition 14.11. PRT2CF: Port2 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA6

Bits7–0: PRT2CF.[7:0]: Output Configuration Bits for P2.7–P2.0 (respectively)
0: Corresponding P2.n Output Mode is Open-Drain.
1: Corresponding P2.n Output Mode is Push-Pull.

SFR Definition 15.1. SPI0CFG: SPI Configuration

R/W	R/W	R	R	R	R/W	R/W	R/W	Reset Value
CKPHA	CKPOL	BC2	BC1	BC0	SPIFRS2	SPIFRS1	SPIFRS0	00000111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x9A

Bit7: CKPHA: SPI Clock Phase.
This bit controls the SPI clock phase.
0: Data sampled on first edge of SCK period.
1: Data sampled on second edge of SCK period.

Bit6: CKPOL: SPI Clock Polarity.
This bit controls the SPI clock polarity.
0: SCK line low in idle state.
1: SCK line high in idle state.

Bits5–3: BC2–BC0: SPI Bit Count.
Indicates which of the up to 8 bits of the SPI word have been transmitted.

BC2–BC0			Bit Transmitted
0	0	0	Bit 0 (LSB)
0	0	1	Bit 1
0	1	0	Bit 2
0	1	1	Bit 3
1	0	0	Bit 4
1	0	1	Bit 5
1	1	0	Bit 6
1	1	1	Bit 7 (MSB)

Bits2–0: SPIFRS2–SPIFRS0: SPI Frame Size.
These three bits determine the number of bits to shift in/out of the SPI shift register during a data transfer in master mode. They are ignored in slave mode.

SPIFRS			Bits Shifted
0	0	0	1
0	0	1	2
0	1	0	3
0	1	1	4
1	0	0	5
1	0	1	6
1	1	0	7
1	1	1	8

17. Timers

The CIP-51 implements three, 16-bit counter/timers comparable with those found in the standard 8051 MCU's. These can be used to measure time intervals, count external events and generate periodic interrupt requests. Timer 0 and Timer 1 are nearly identical and have four primary modes of operation. Timer 2 offers additional capabilities not available in Timers 0 and 1, such as capture and baud rate generation.

Timer 0 and Timer 1:	Timer 2:
13-bit counter/timer	16-bit counter/timer with auto-reload
16-bit counter/timer	16-bit counter/timer with capture
8-bit counter/timer with auto-reload	Baud rate generator
Two 8-bit counter/timers (Timer 0 only)	

When functioning as a timer, the counter/timer registers are incremented on each clock tick. Clock ticks are derived from the system clock divided by either one or twelve as specified by the Timer Clock Select bits (T2M–T0M) in CKCON. The twelve-clocks-per-tick option provides compatibility with the older generation of the 8051 family. Applications that require a faster timer can use the one-clock-per-tick option.

When functioning as a counter, a counter/timer register is incremented on each high-to-low transition at the selected input pin (P0.4/T0, P0.5/T1, or P0.6/T2. Events with a frequency of up to one-fourth the system clock's frequency can be counted. The input signal need not be periodic, but it should be held at a given level for at least two full system clock cycles to ensure the level is sampled.

17.1. Timer 0 and Timer 1

Timer 0 and Timer 1 are accessed and controlled through SFR's. Each counter/timer is implemented as a 16-bit register accessed as two separate bytes: a low byte (TL0 or TL1) and a high byte (TH0 or TH1). The Counter/Timer Control (TCON) register is used to enable Timer 0 and Timer 1 as well as indicate their status. Both counter/timers operate in one of four primary modes selected by setting the Mode Select bits M1–M0 in the Counter/Timer Mode (TMOD) register. Each timer can be configured independently. Following is a detailed description of each operating mode.

17.1.1. Mode 0: 13-bit Counter/Timer

Timer 0 and Timer 1 operate as a 13-bit counter/timer in Mode 0. The following describes the configuration and operation of Timer 0. However, both timers operate identically and Timer 1 is configured in the same manner as described for Timer 0.

The TH0 register holds the eight MSB's of the 13-bit counter/timer. TL0 holds the five LSBs in bit positions TL0.4–TL0.0. The three upper bits of TL0 (TL0.7–TL0.5) are indeterminate and should be masked out or ignored when reading. As the 13-bit timer register increments and overflows from 0x1FFF (all ones) to 0x0000, the timer overflow flag TF0 (TCON.5) is set and an interrupt will occur if enabled.

The C/T0 bit (TMOD.2) selects the counter/timer's clock source. Clearing C/T selects the system clock as the input for the timer. When C/T0 is set to logic 1, high-to-low transitions at the selected input pin increment the timer register. (Refer to section 14 for information on selecting and configuring external I/O pins.)

Setting the TR0 bit (TCON.4) enables the timer when either GATE0 (TMOD.3) is 0 or the input signal /INT0 is logic-level one. Setting GATE0 to logic 1 allows the timer to be controlled by the external input signal /INT0, facilitating pulse width measurements.

17.2. Timer 2

Timer 2 is a 16-bit counter/timer formed by the two 8-bit SFR's: TL2 (low byte) and TH2 (high byte). As with Timers 0 and 1, Timer 2 can use either the system clock or transitions on an external input pin as its clock source. The Counter/Timer Select bit C/T2 bit (T2CON.1) selects the clock source for Timer 2. Clearing C/T2 selects the system clock as the input for the timer (divided by either one or twelve as specified by the Timer Clock Select bit T2M in CKCON). When C/T2 is set to 1, high-to-low transitions at the T2 input pin increment the counter/timer register. (Refer to Section 14 for information on selecting and configuring external I/O pins.) Timer 2 can also be used to start an ADC Data Conversion (see section 5).

Timer 2 offers capabilities not found in Timer 0 and Timer 1. It operates in one of three modes: 16-bit Counter/Timer with Capture, 16-bit Counter/Timer with Auto-Reload or Baud Rate Generator Mode. Timer 2's operating mode is selected by setting configuration bits in the Timer 2 Control (T2CON) register. Below is a summary of the Timer 2 operating modes and the T2CON bits used to configure the counter/timer. Detailed descriptions of each mode follow.

RCLK	TCLK	CP/RL2	TR2	Mode
0	0	1	1	16-bit Counter/Timer with Capture
0	0	0	1	16-bit Counter/Timer with Auto-Reload
0	1	X	1	Baud Rate Generator for TX
1	0	X	1	Baud Rate Generator for RX
1	1	X	1	Baud Rate Generator for TX and RX
X	X	X	0	Off

SFR Definition 17.8. T2CON: Timer 2 Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xC8

Bit7: TF2: Timer 2 Overflow Flag.
Set by hardware when Timer 2 overflows from 0xFFFF to 0x0000. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software. TF2 will not be set when RCLK and/or TCLK are logic 1.

Bit6: EXF2: Timer 2 External Flag.
Set by hardware when either a capture or reload is caused by a high-to-low transition on the T2EX input pin and EXEN2 is logic 1. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 Interrupt service routine. This bit is not automatically cleared by hardware and must be cleared by software.

Bit5: RCLK: Receive Clock Flag.
Selects which timer is used for the UART's receive clock in modes 1 or 3.
0: Timer 1 overflows used for receive clock.
1: Timer 2 overflows used for receive clock.

Bit4: TCLK: Transmit Clock Flag.
Selects which timer is used for the UART's transmit clock in modes 1 or 3.
0: Timer 1 overflows used for transmit clock.
1: Timer 2 overflows used for transmit clock.

Bit3: EXEN2: Timer 2 External Enable.
Enables high-to-low transitions on T2EX to trigger captures or reloads when Timer 2 is not operating in Baud Rate Generator mode.
0: High-to-low transitions on T2EX ignored.
1: High-to-low transitions on T2EX cause a capture or reload.

Bit2: TR2: Timer 2 Run Control.
This bit enables/disables Timer 2.
0: Timer 2 disabled.
1: Timer 2 enabled.

Bit1: C/T2: Counter/Timer Select.
0: Timer Function: Timer 2 incremented by clock defined by T2M (CKCON.5).
1: Counter Function: Timer 2 incremented by high-to-low transitions on external input pin P0.6/T2.

Bit0: CP/RL2: Capture/Reload Select.
This bit selects whether Timer 2 functions in capture or auto-reload mode. EXEN2 must be logic 1 for high-to-low transitions on T2EX to be recognized and used to trigger captures or reloads. If RCLK or TCLK is set, this bit is ignored and Timer 2 will function in auto-reload mode.
0: Auto-reload on Timer 2 overflow or high-to-low transition at T2EX (EXEN2 = 1).
1: Capture on high-to-low transition at T2EX (EXEN2 = 1).

SFR Definition 17.9. RCAP2L: Timer 2 Capture Register Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCA

Bits 7–0: RCAP2L: Timer 2 Capture Register Low Byte.
The RCAP2L register captures the low byte of Timer 2 when Timer 2 is configured in capture mode. When Timer 2 is configured in auto-reload mode, it holds the low byte of the reload value.

SFR Definition 17.10. RCAP2H: Timer 2 Capture Register High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCB

Bits 7–0: RCAP2H: Timer 2 Capture Register High Byte.
The RCAP2H register captures the high byte of Timer 2 when Timer 2 is configured in capture mode. When Timer 2 is configured in auto-reload mode, it holds the high byte of the reload value.

SFR Definition 17.11. TL2: Timer 2 Low Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCC

Bits 7–0: TL2: Timer 2 Low Byte.
The TL2 register contains the low byte of the 16-bit Timer 2.

SFR Definition 17.12. TH2: Timer 2 High Byte

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xCD

Bits 7–0: TH2: Timer 2 High Byte.
The TH2 register contains the high byte of the 16-bit Timer 2.

18.1. Flash Programming Commands

The Flash memory can be programmed directly over the JTAG interface using the Flash Control, Flash Data, Flash Address, and Flash Scale registers. These Indirect Data Registers are accessed via the JTAG Instruction Register. Read and write operations on indirect data registers are performed by first setting the appropriate DR address in the IR register. Each read or write is then initiated by writing the appropriate Indirect Operation Code (IndOpCode) to the selected data register. Incoming commands to this register have the following format:

19:18	17:0
IndOpCode	**WriteData**

IndOpCode: These bit set the operation to perform according to the following table:

IndOpCode	Operation
0x	Poll
10	Read
11	Write

The Poll operation is used to check the Busy bit as described below. Although a Capture-DR is performed, no Update-DR is allowed for the Poll operation. Since updates are disabled, polling can be accomplished by shifting in/out a single bit.

The Read operation initiates a read from the register addressed by the DRAddress. Reads can be initiated by shifting only 2 bits into the indirect register. After the read operation is initiated, polling of the Busy bit must be performed to determine when the operation is complete.

The write operation initiates a write of WriteData to the register addressed by DRAddress. Registers of any width up to 18 bits can be written. If the register to be written contains fewer than 18 bits, the data in WriteData should be left-justified, i.e. its MSB should occupy bit 17 above. This allows shorter registers to be written in fewer JTAG clock cycles. For example, an 8-bit register could be written by shifting only 10 bits. After a Write is initiated, the Busy bit should be polled to determine when the next operation can be initiated. The contents of the Instruction Register should not be altered while either a read or write operation is in progress.

Outgoing data from the indirect Data Register has the following format:

19	18:5	0
0	**ReadData**	**Busy**

The Busy bit indicates that the current operation is not complete. It goes high when an operation is initiated and returns low when complete. Read and Write commands are ignored while Busy is high. In fact, if polling for Busy to be low will be followed by another read or write operation, JTAG writes of the next operation can be made while checking for Busy to be low. They will be ignored until Busy is read low, at which time the new operation will initiate. This bit is placed at bit 0 to allow polling by single-bit shifts. When waiting for a Read to complete and Busy is 0, the following 18 bits can be shifted out to obtain the resulting data. ReadData is always right-justified. This allows registers shorter than 18 bits to be read using a reduced number of shifts. For example, the result from a byte-read requires 9 bit shifts (Busy + 8 bits).